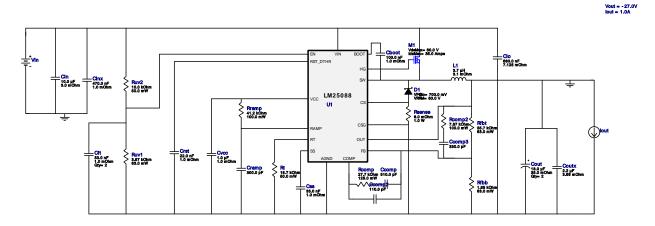


VinMin = 4.5V VinMax = 5.5V Vout = -27.0V Iout = 1.0A Device = LM25088MH-1/NOPB Topology = Inverting\_Buck\_Boost Created = 2019-06-19 12:44:18.882 BOM Cost = \$2.65 BOM Count = 24 Total Pd = 3.36W

# WEBENCH® Design Report

Design: 7 LM25088MH-1/NOPB LM25088MH-1/NOPB 4.5V-5.5V to -27.00V @ 1A

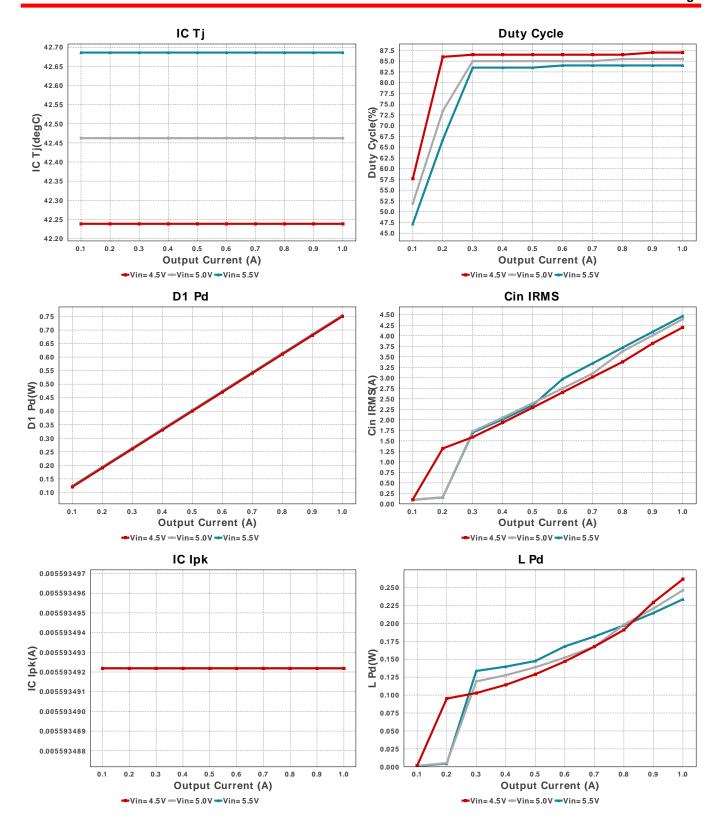


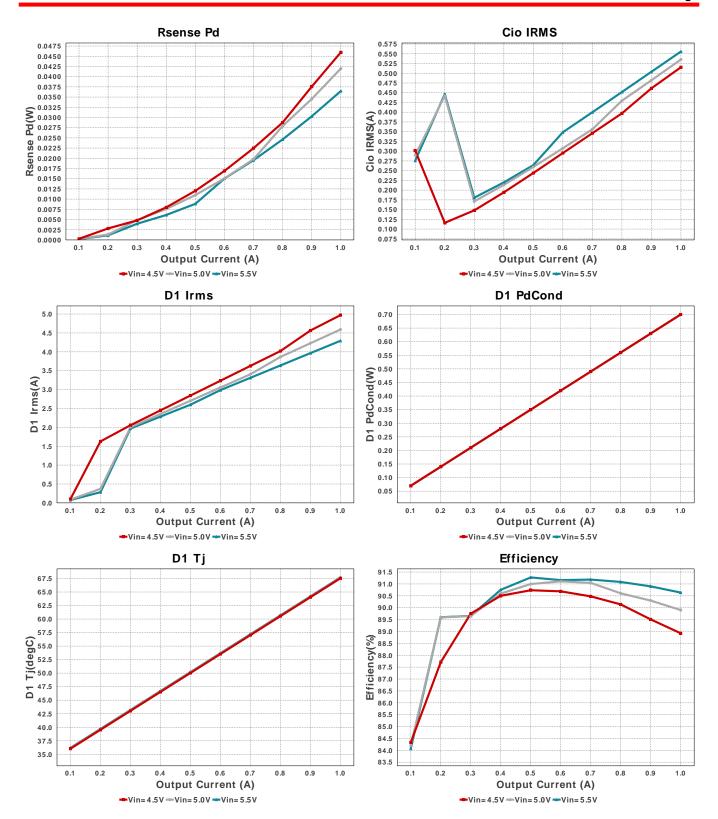
#### **Electrical BOM**

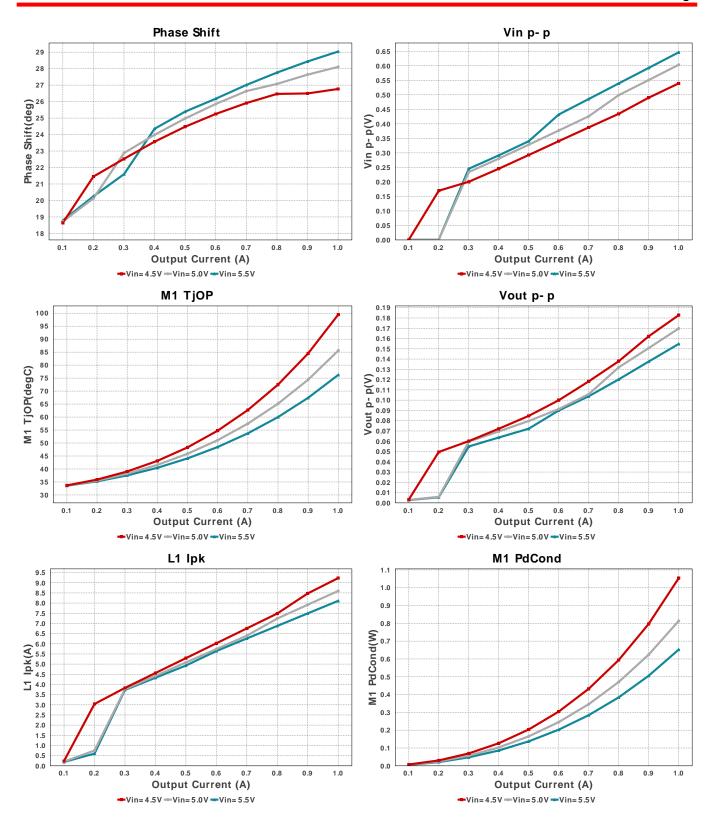
Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Cboot	MuRata	GRM155R71C104KA88D Series= X7R	Cap= 100.0 nF ESR= 1.0 mOhm VDC= 16.0 V IRMS= 0.0 A	1	\$0.01	0402 3 mm <sup>2</sup>
Ccomp	MuRata	GRM1555C1H511GA01D Series= C0G/NP0	Cap= 510.0 pF VDC= 50.0 V IRMS= 0.0 A	1	\$0.03	0402 3 mm <sup>2</sup>
Ccomp2	MuRata	GRM0335C1H111JA01D Series= C0G/NP0	Cap= 110.0 pF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	0201 2 mm <sup>2</sup>
Ccomp3	Samsung Electro- Mechanics	CL21C331JBANNNC Series= C0G/NP0	Cap= 330.0 pF VDC= 50.0 V IRMS= 0.0 A	1	\$0.01	0805 7 mm <sup>2</sup>
Cft	MuRata	GRM155R71E333KA88D Series= X7R	Cap= 33.0 nF ESR= 1.0 mOhm VDC= 25.0 V IRMS= 0.0 A	2	\$0.01	0402 3 mm <sup>2</sup>
Cin	Kemet	C0805C106K8PACTU Series= X5R	Cap= 10.0 uF ESR= 3.0 mOhm VDC= 10.0 V IRMS= 11.43 A	1	\$0.03	0805 7 mm <sup>2</sup>
Cinx	Taiyo Yuden	TMK212BJ474KD-T Series= X5R	Cap= 470.0 nF ESR= 1.0 mOhm VDC= 20.0 V IRMS= 0.0 A	1	\$0.02	0805 7 mm <sup>2</sup>
Cio	TDK	C1608X5R1H684K080AB Series= X5R	Cap= 680.0 nF ESR= 7.125 mOhm VDC= 50.0 V IRMS= 1.9522 A	1	\$0.05	0603 5 mm <sup>2</sup>
Cout	Panasonic	50SVPF18M Series= SVPF	Cap= 18.0 uF ESR= 35.0 mOhm VDC= 50.0 V IRMS= 2.7 A	2	\$0.54	CAPSMT_62_E7 106 mm <sup>2</sup>
Coutx	TDK	C2012X5R1H225K125AB Series= X5R	Cap= 2.2 uF ESR= 3.66 mOhm VDC= 50.0 V IRMS= 3.4121 A	1	\$0.15	0805 7 mm <sup>2</sup>

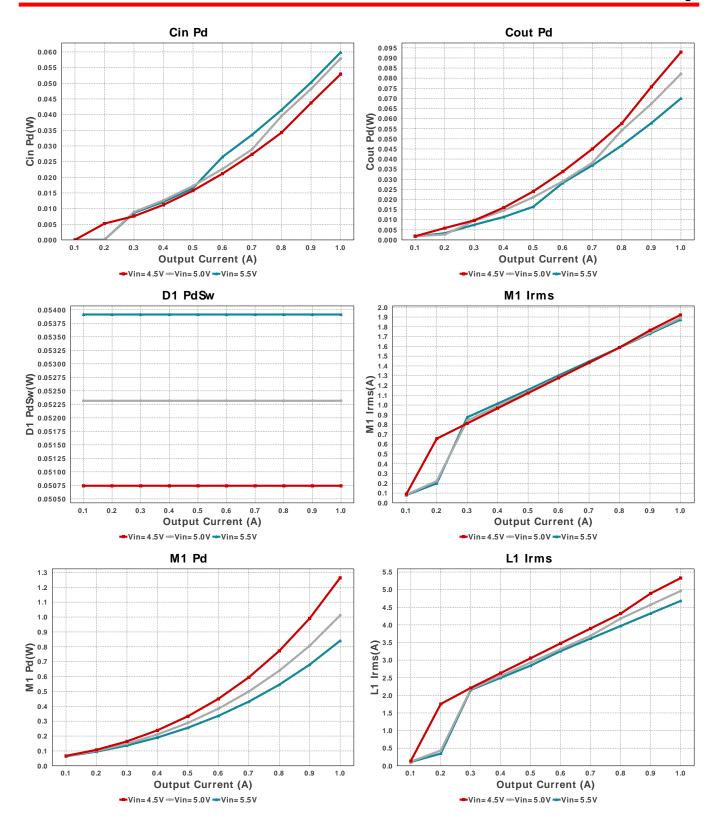
Rcomp         Yageo         RT0805BRD0727K7L Series= RT0805         Res= 27.7 kOhm Power= 125.0 mW Tolerance= 0.1%         1         \$0.05         ■ 0805 7 mm² 0805 7 mm² 0805 7 mm²           Rcomp2         Yageo         RC0603FR-077K87L Series=?         Res= 7.87 kOhm Power= 100.0 mW Tolerance= 1.0%         1         \$0.01         ■ 0603 5 mm²           Rfbb         Vishay-Dale         CRCW04021K65FKED Series= CRCW.e3         Res= 1.65 kOhm Power= 63.0 mW Tolerance= 1.0%         1         \$0.01         ■ 0402 3 mm²           Rfbt         Vishay-Dale         CRCW040235K7FKED Series= CRCW.e3         Res= 35.7 kOhm Power= 63.0 mW Tolerance= 1.0%         1         \$0.01         ■ 0402 3 mm²           Rramp         Vishay-Dale         CRCW060341K2FKEA Series= CRCW.e3         Res= 41.2 kOhm Power= 10.0%         1         \$0.01         ■ 0603 5 mm²           Rsense         Susumu Co Ltd         PRL1632-R006-F-T1 Res= 6.0 mOhm Tolerance= 1.0%         1         \$0.20         ■ 0603 5 mm²           Rt         Yageo         RC0201FR-0718K7L Res= 18.7 kOhm Power= 50.0 mW Tolerance= 1.0%         1         \$0.01         ■ 0201 2 mm²           Ruv1         Vishay-Dale         CRCW04023K57FKED Res= 3.57 kOhm Power= 63.0 mW Tolerance= 1.0%         1         \$0.01         ■ 0402 3 mm²           Ruv2         Yageo         RC0201FR-0710KL Series= ?         Res= 10.0 kOhm Power=	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
Series= XSR	Cramp			VDC= 50.0 V	1	\$0.01	
Series= X7R	Crst	MuRata		ESR= 1.0 mOhm VDC= 6.3 V	1	\$0.01	0201 2 mm <sup>2</sup>
Series= X7R	Css	MuRata		ESR= 1.0 mOhm VDC= 25.0 V	1	\$0.01	
VRRM= 60.0 V	Cvcc	Taiyo Yuden		ESR= 1.0 mOhm VDC= 16.0 V	1	\$0.02	0603 5 mm <sup>2</sup>
MIC1565 243 mm	D1	Diodes Inc.	B560C-13-F		1	\$0.17	SMC 83 mm <sup>2</sup>
M1         Texas Instruments         CSD18543Q3A         VdsMax= 60.0 V IdsMax= 35.0 Amps         1         \$0.27           Rcomp         Yageo         RT0805BRD0727K7L Series= RT0805         Res= 27.7 kOhm Power= 125.0 mW Tolerance= 0.1%         1         \$0.05         ■           Rcomp2         Yageo         RC0603FR-077K87L Series=?         Res= 7.87 kOhm Power= 100.0 mW Tolerance= 1.0%         1         \$0.01         ■           Rfbb         Vishay-Dale         CRCW04021K65FKED Series= CRCW.e3         Res= 1.65 kOhm Power= 63.0 mW Tolerance= 1.0%         1         \$0.01         ■           Rfbt         Vishay-Dale         CRCW040235K7FKED Series= CRCW.e3         Res= 35.7 kOhm Power= 63.0 mW Tolerance= 1.0%         1         \$0.01         ■           Rramp         Vishay-Dale         CRCW060341K2FKEA Series= CRCW.e3         Res= 41.2 kOhm Power= 63.0 mW Tolerance= 1.0%         1         \$0.01         ■           Rsense         Susumu Co Ltd         PRL1632-R006-F-T1 Series= PRL1632         Res= 6.0 mOhm Power= 1.0 W Tolerance= 1.0%         1         \$0.20         ■           Rt         Yageo         RC0201FR-0718K7L Series= CRCW.e3         Res= 18.7 kOhm Power= 50.0 mW Tolerance= 1.0%         1         \$0.01         ■           Ruv1         Vishay-Dale         CRCW04023K57FKED Series= CRCW.e3         Res= 18.7 kOhm Power= 50.0 mW Toleranc	L1	Coilcraft	MLC1565-372MLB		1	\$1.05	MI C1565 243 mm <sup>2</sup>
Series= RT0805	M1	Texas Instruments	CSD18543Q3A		1	\$0.27	DNH0008A 18 mm²
Series   Power   100.0 mW Tolerance   1.0%   1	Rcomp	Yageo		Power= 125.0 mW	1	\$0.05	<del></del> -
Series	Rcomp2	Yageo		Power= 100.0 mW	1	\$0.01	
Series= CRCWe3	Rfbb	Vishay-Dale		Power= 63.0 mW	1	\$0.01	
Series	Rfbt	Vishay-Dale		Power= 63.0 mW	1	\$0.01	
Series= PRL1632	Rramp	Vishay-Dale		Power= 100.0 mW	1	\$0.01	
Series= ?  Power= 50.0 mW Tolerance= 1.0%  Ruv1 Vishay-Dale  CRCW04023K57FKED Series= CRCWe3  Power= 63.0 mW Tolerance= 1.0%  Ruv2 Yage0  RC0201FR-0710KL Series= ?  Power= 50.0 mW Tolerance= 1.0%  Res= 10.0 kOhm Power= 50.0 mW Tolerance= 1.0%	Rsense	Susumu Co Ltd		Power= 1.0 W	1	\$0.20	_
Series= CRCWe3	Rt	Yageo		Power= 50.0 mW	1	\$0.01	
Series= ? Power= 50.0 mW 0201 2 mm <sup>2</sup> Tolerance= 1.0%	Ruv1	Vishay-Dale		Power= 63.0 mW	1	\$0.01	
U1 Texas Instruments LM25088MH-1/NOPB Switcher 1 \$1.50	Ruv2	Yageo		Power= 50.0 mW	1	\$0.01	0201 2 mm <sup>2</sup>
MVA16A 50 mm²	U1	Texas Instruments	LM25088MH-1/NOPB	Switcher	1	\$1.50	

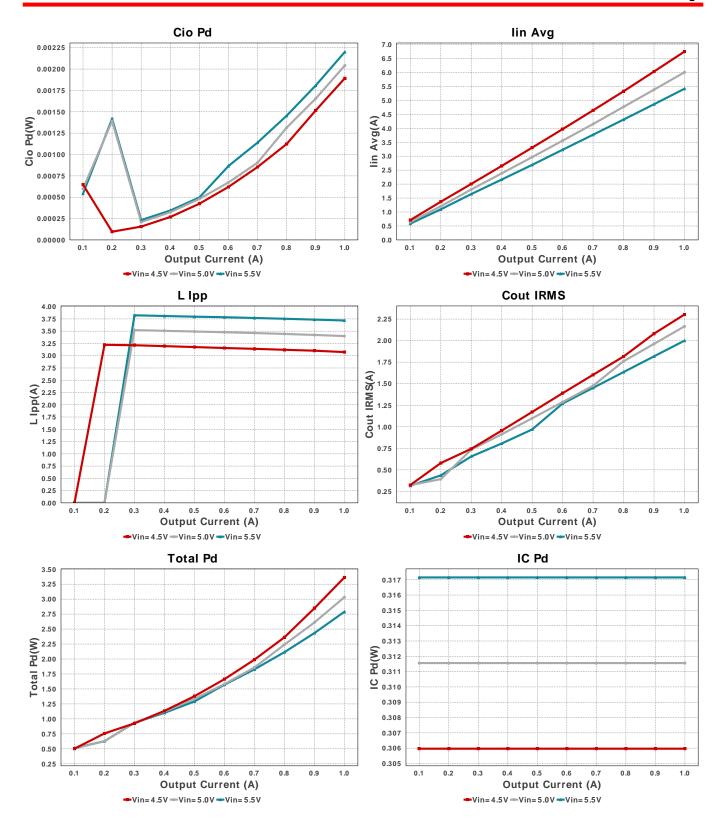
MXA16A 59 mm<sup>2</sup>

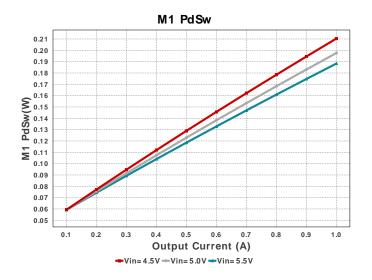


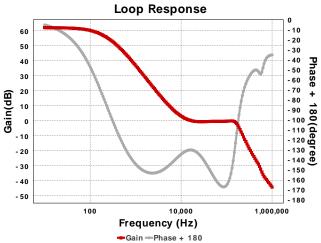












### **Operating Values**

#	Name	Value	Category	Description
	Cin IRMS			•
1. 2.	Cin IRMS Cin Pd	4.199 A	Capacitor	Input capacitor RMS ripple current
		52.883 mW	Capacitor	Input capacitor power dissipation
3.	Cio IRMS	515.355 mA	Capacitor	Input to output capacitor RMS ripple current
4.	Cio Pd	1.892 mW	Capacitor	Input to output capacitor power dissipation
5.	Cout IRMS	2.303 A	Capacitor	Output capacitor RMS ripple current
6.	Cout Pd	92.853 mW	Capacitor	Output capacitor power dissipation
7.	D1 Irms	4.97 A	Current	D1 Irms
8.	D1 Pd	750.742 mW	Diode	Diode power dissipation
9.	D1 PdCond	700.0 mW	Diode	Diode conduction losses
10.		50.742 mW	Diode	Diode switching losses
11.	,	67.537 degC	Diode	D1 junction temperature
	IC lpk	5.593 mA	IC	Peak switch current in IC
13.	IC Pd	305.964 mW	IC	IC power dissipation
14.	IC Tj	42.239 degC	IC	IC junction temperature
15.	IC Tolerance	18.0 mV	IC	IC Feedback Tolerance
16.	lin Avg	6.747 A	IC	Average input current
17.	L lpp	3.074 A	Inductor	Peak-to-peak output inductor ripple current
18.	L Pd	261.489 mW	Inductor	Inductor power dissipation
19.	L1 lpk	9.229 A	Inductor	Inductor peak current
20.	L1 Irms	5.328 A	Inductor	Inductor ripple current
21.	M1 Irms	1.921 A	Mosfet	M1 MOSFET Irms
22.	M1 Pd	1.264 W	Mosfet	M1 MOSFET total power dissipation
23.	M1 PdCond	1.053 W	Mosfet	M1 MOSFET conduction losses
24.	M1 PdSw	210.385 mW	Mosfet	M1 MOSFET switching losses
25.	M1 TjOP	99.509 degC	Mosfet	M1 MOSFET junction temperature
26.	IOUT_OP	1.0 A	Op Point	lout operating point
27.	VIN_OP	4.5 V	Op Point	Vin operating point
28.	Total Pd	3.363 W	Power	Total Power Dissipation
29.	Rsense Pd	45.956 mW	Resistor	LED Current Rsns Power Dissipation
30.	BOM Count	24	System Information	Total Design BOM count
31.	Cross Freq	16.447 kHz	System Information	Bode plot crossover frequency
32.	Duty Cycle	87.0 %	System	Duty cycle
			Information	
33.	Efficiency	88.924 %	System Information	Steady state efficiency
3/	FootPrint	250.0 mm²	System	Total Foot Print Area of BOM components
		250.0 mm²	Information	·
35.	Frequency	320.266 kHz	System Information	Switching frequency
36.	Gain Marg	44.365 db	System Information	Bode Plot Gain Margin
37.	Mode	DCM	System Information	Conduction Mode
38.	Phase Marg	49.904 deg	System Information	Bode Plot Phase Margin
39.	Phase Shift	26.767 deg	System	Bode Plot Phase Shift
40.	Total BOM	\$2.65	Information System Information	Total BOM Cost

#	Name	Value	Category	Description
41.	Vin p-p	539.237 mV	System	Peak-to-peak input voltage
			Information	
42.	Vout p-p	182.732 mV	System	Peak-to-peak output ripple voltage
			Information	

### **Design Inputs**

Name	Value	Description	
lout	1.0	Maximum Output Current	
VinMax	5.5	Maximum input voltage	
VinMin	4.5	Minimum input voltage	
VinTyp	5.0	Typical input voltage	
Vout	-27.0	Output Voltage	
base_pn	LM25088	Base Product Number	
source	DC	Input Source Type	
Та	30.0	Ambient temperature	
UserFsw	317.5 k	Customer Selected Frequency	

## WEBENCH® Assembly

### Component Testing

Some published data on components in datasheets such as Capacitor ESR and Inductor DC resistance is based on conservative values that will guarantee that the components always exceed the specification. For design purposes it is usually better to work with typical values. Since this data is not always available it is a good practice to measure the Capacitance and ESR values of Cin and Cout, and the inductance and DC resistance of L1 before assembly of the board. Any large discrepancies in values should be electrically simulated in WEBENCH to check for instabilities and thermally simulated in WebTHERM to make sure critical temperatures are not exceeded.

#### Soldering Component to Board

If board assembly is done in house it is best to tack down one terminal of a component on the board then solder the other terminal. For surface mount parts with large tabs, such as the DPAK, the tab on the back of the package should be pre-tinned with solder, then tacked into place by one of the pins. To solder the tab town to the board place the iron down on the board while resting against the tab, heating both surfaces simultaneously. Apply light pressure to the top of the plastic case until the solder flows around the part and the part is flush with the PCB. If the solder is not flowing around the board you may need a higher wattage iron (generally 25W to 30W is enough).

### Initial Startup of Circuit

It is best to initially power up the board by setting the input supply voltage to the lowest operating input voltage 4.5V and set the input supply's current limit to zero. With the input supply off connect up the input supply to Vin and GND. Connect a digital volt meter and a load if needed to set the minimum lout of the design from Vout and GND. Turn on the input supply and slowly turn up the current limit on the input supply. If the voltage starts to rise on the input supply continue increasing the input supply current limit while watching the output voltage. If the current increases on the input supply, but the voltage remains near zero, then there may be a short or a component misplaced on the board. Power down the board and visually inspect for solder bridges and recheck the diode and capacitor polarities. Once the power supply circuit is operational then more extensive testing may include full load testing, transient load and line tests to compare with simulation results.

#### Load Testing

The setup is the same as the initial startup, except that an additional digital voltmeter is connected between Vin and GND, a load is connected between Vout and GND and a current meter is connected in series between Vout and the load. The load must be able to handle at least rated output power + 50% (7.5 watts for this design). Ideally the load is supplied in the form of a variable load test unit. It can also be done in the form of suitably large power resistors. When using an oscilloscope to measure waveforms on the prototype board, the ground leads of the oscilloscope probes should be as short as possible and the area of the loop formed by the ground lead should be kept to a minimum. This will help reduce ground lead inductance and eliminate EMI noise that is not actually present in the circuit.



#### **Design Assistance**

- 1. Master key: E56AD4253327D321[v1]
- 2. LM25088 Product Folder: http://www.ti.com/product/LM25088: contains the data sheet and other resources.

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